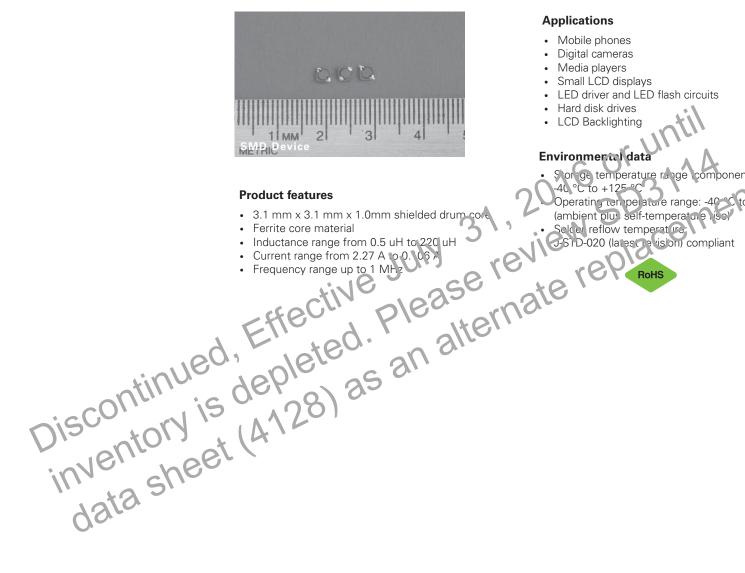
SD3110

Low profile shielded drum core power inductors



Applications

- Mobile phones
- Digital cameras

- Sologe temperature range component):
 -40 °C to +125 °C
 - Operating temperature range: -40°C to +125°C



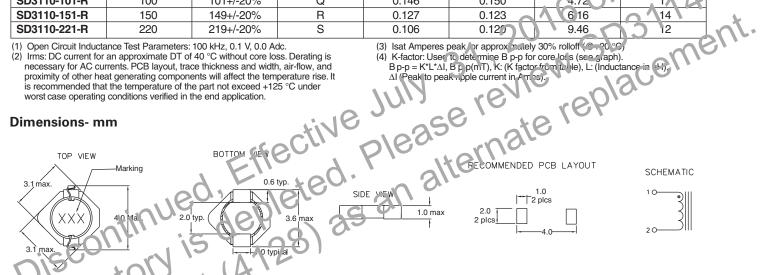
Product specifications

| Part Number | Rated Inductance (µH) | OCL (1) (μH) | Part Marking Designator | Irms (2) (A) | Isat (3) (A) | DCR (Ω) typ. @ +20 °C | K-factor (4) |
|--------------|-----------------------------|-----------------|-------------------------------|-----------------|-----------------|-----------------------------|-----------------|
| SD3110-R50-R | 0.50 | 0.44+/-30% | Α | 1.54 | 2.27 | 0.0420 | 216 |
| SD3110-R82-R | 0.82 | 0.82+/-30% | В | 1.30 | 1.67 | 0.0589 | 191 |
| SD3110-1R0-R | 1.0 | 1.05+/-30% | С | 1.21 | 1.47 | 0.0683 | 169 |
| SD3110-1R5-R | 1.5 | 1.60+/-30% | D | 0.99 | 1.19 | 0.103 | 137 |
| SD3110-2R2-R | 2.2 | 2.27+/-30% | E | 0.82 | 1.00 | 0.149 | 115 |
| SD3110-3R3-R | 3.3 | 3.48+/-30% | F | 0.72 | 0.81 | 0.195 | 93 |
| SD3110-4R7-R | 4.7 | 4.96+/-30% | G | 0.59 | 0.68 | 0.285 | 78 |
| SD3110-6R8-R | 6.8 | 6.70+/-30% | Н | 0.54 | 0.58 | 0.346 | 67 |
| SD3110-8R2-R | 8.2 | 8.01+/-30% | I | 0.48 | 0.53 | 0.432 | 61 |
| SD3110-100-R | 10.0 | 10.18+/-30% | J | 0.44 | 0.47 | 0.505 | 54 |
| SD3110-150-R | 15.0 | 15.32+/-20% | K | 0.36 | 0.38 | 0.764 | 44 |
| SD3110-220-R | 22.0 | 21.49+/-20% | L | 0.30 | 0.32 | 1.13 | 37 |
| SD3110-330-R | 33.0 | 32.72+/-20% | M | 0.26 | 0.26 | 1.50 | 30 |
| SD3110-470-R | 47.0 | 46.29+/-20% | N | 0.22 | 0.22 | 2.06 | 26 |
| SD3110-680-R | 68.0 | 68.04+/-20% | 0 | 0.179 | 0.182 | 3.13 | 21 |
| SD3110-820-R | 82.0 | 82.65+/-20% | Р | 0.167 | 0.166 | 3.57 | 19 |
| SD3110-101-R | 100 | 101+/-20% | Q | 0.146 | 0.150 | 4.72 | 17 |
| SD3110-151-R | 150 | 149+/-20% | R | 0.127 | 0.123 | 616 | 14 |
| SD3110-221-R | 220 | 219+/-20% | S | 0.106 | 0.120 | 9.46 | 12 |

⁽¹⁾ Open Circuit Inductance Test Parameters: 100 kHz, 0.1 V, 0.0 Adc.

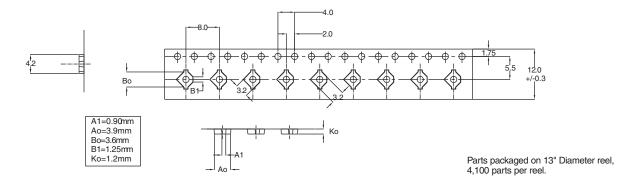
(3) Isat Amperes peak or approximately 30% rolloff (2.,?o.°C) (4) K-factor: User it determine B p-p for core loss (sco-graph).

Dimensions- mm



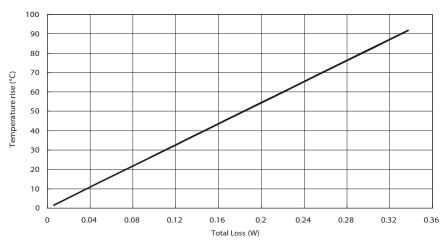
Part Ma king:
3 Digit Marking: (1st digit. I), licates inductance value per letter in Part Marking Designator); (2nd digit: Bi-weekly production date code); (3rd digit: Last digit of the year produced).
Do not route trade on vivo underneath the inductor

Packaging information- mm

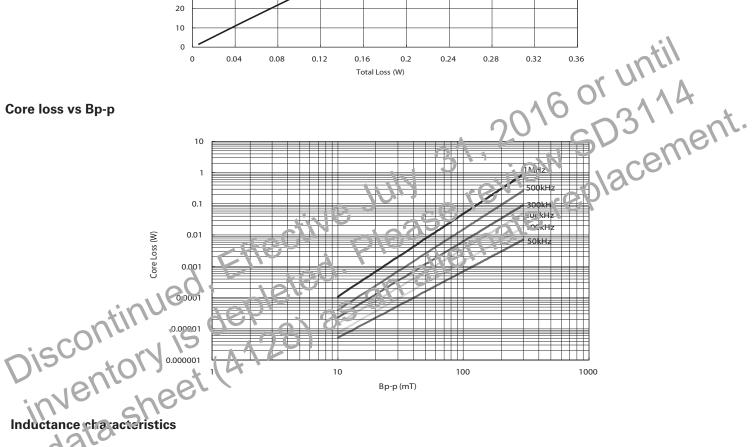


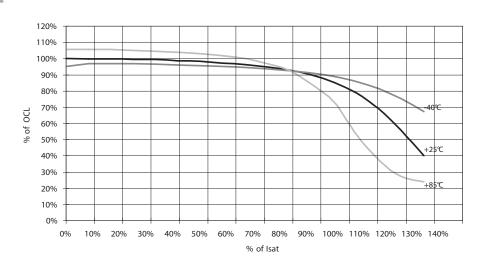
⁽²⁾ Irms: DC current for an approximate DT of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125 $^{\circ}$ C under worst case operating conditions verified in the end application.

Temperature rise vs total loss loss



Core loss vs Bp-p





Solder Reflow Profile

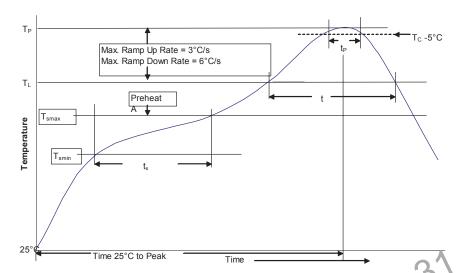


Table 1 - Standard SnPb Solder (T_c)

| | Volume | Volume | |
|-----------|--------|--------|--|
| Package | mm³ | mm³ | |
| Thickness | <350 | ≥350 | |
| <2.5mm | 235°C | 220°C | |
| ≥2.5mm | 220°C | 220°C | |

Table 2 - Lead (Pb) Free Solder (Tc)

| | Volume | Volume , * | Volume |
|-------------|----------|------------|--------|
| Package | mm³ | mm³ | mm³ |
| Thickness | <350 | 350 - 2000 | >2000 |
| <1.6mm | 260°C | 260°C | 260°C |
| 1.6 - 2.5mm | 1 260 °C | 250°C | 27.5°C |
| >2.5mni | 250°C | 215 0 | 245°C |

Reference JDEC J-STD-020

| 1.6 - 2.5 >2.5 | 17 250 C 250 C 275 C 250°C 245°C | |
|-------------------------|--|--|
| 31, liew stacemer | | |
| Standard Shi b Solder | Leea (Pb) Free Solder | |
| CO 100°C + C | 150°C | |
| 150°C | 200°C | |
| 60-120 Seconds | 60-120 Seconds | |
| 3 C/ Second Max. | 3°C/ Second Max. | |
| 183°C | 217°C | |
| 60-150 Seconds | 60-150 Seconds | |
| Table 1 | Table 2 | |
| 20 Seconds** | 30 Seconds** | |
| 6°C/ Second Max. | 6°C/ Second Max. | |
| 6 Minutes Max. | 8 Minutes Max. | |
| | Standaro Sn. b Solder 100°C 150°C 60-120 Seconds 3 °C Second Max. 183°C 60-150 Seconds Table 1 20 Seconds** 6°C/ Second Max. | |

 $^{^\}star$ Tolera, we for peak profile remove ature (Tp) is defined as a supplier minimum and a user maximum.

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^{*}Nerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.